

ROUND TYPE LED LAMPS

LH2041

DATA SHEET

DOC. NO :		QW0905-LH2041			
REV.	:	Α			
DATE	:	07 - Mar 2005			



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Absolute Maximum Ratings at Ta=25

Parameter	Symbol	Ratings	UNIT	
Farameter	Symbol	н		
Forward Current	lF	15	mA	
Peak Forward Current Duty 1/10@10KHz	IFP	60	mA	
Power Dissipation	PD	40	mW	
Reverse Current @5V	lr	10	μA	
Operating Temperature	Topr	-40 ~ +85		
Storage Temperature	Tstg	-40 ~ +100		
Soldering Temperature	Tsol	Max 260 for 5 sec Max (2mm from body)		

Typical Electrical & Optical Characteristics (Ta=25)

PART NO	MATERIAL	COLOR		Peak wave length Pnm	Spectral halfwidth nm			Luminous intensity @10mA(mcd)		Viewing angle 2 1/2 (deg)
		Emitted	Lens			Min.	Max.	Min.	Тур.	
LH2041	GaP	Red	Red Transparent	697	90	1.7	2.6	4.5	8.0	30

Note : 1. The forward voltage data did not including $\pm 0.1V$ testing tolerance.

2. The luminous intensity data did not including ±15% testing tolerance.



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Fig.2 Relative Intensity vs. Forward Current

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Typical Electro-Optical Characteristics Curve

H CHIP

Fig.1 Forward current vs. Forward Voltage



Fig.3 Forward Voltage vs. Temperature









Relative Intensity Normalize @20mA

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Reliability Test:

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Test Item	Test Condition	Description	Reference Standard
Operating Life Test	1.Under Room Temperature 2.If=20mA 3.t=1000 hrs (-24hrs, +72hrs)	This test is conducted for the purpose of detemining the resisance of a part in electrical and themal stressed.	MIL-STD-750: 102 MIL-STD-883: 100 JIS C 7021: B-1
High Temperature Storage Test	1.Ta=105 ±5 2.t=1000 hrs (-24hrs, +72hrs)	The purpose of this is the resistance of the device which is laid under ondition of hogh temperature for hours.	MIL-STD-883:100 JIS C 7021: B-10
Low Temperature Storage Test	1.Ta=-40 ±5 2.t=1000 hrs (-24hrs, +72hrs)	The purpose of this is the resistance of the device which is laid under condition of low temperature for hours.	JIS C 7021: B-12
High Temperature High Humidity Test	1.Ta=65 ±5 2.RH=90 %~95 % 3.t=240hrs ±2hrs	The purpose of this test is the resistance of the device under tropical for hous.	MIL-STD-202:103 JIS C 7021: B-11
Thermal Shock Test	1.Ta=105 ±5 &-40 ±5 (10min) (10min) 2.total 10 cycles	The purpose of this is the resistance of the device to sudden extreme changes in high and low temperature.	MIL-STD-202: 107 MIL-STD-750: 105 MIL-STD-883: 101
Solder Resistance Test	1.T.Sol=260 ±5 2.Dwell time= 10 ±1sec.	This test intended to determine the thermal characteristic resistance of the device to sudden exposures at extreme changes in temperature when soldering the lead wire.	MIL-STD-202: 210, MIL-STD-750: 203 JIS C 7021: A-1
Solderability Test	1.T.Sol=230 ±5 2.Dwell time=5 ±1sec	This test intended to see soldering well performed or not.	MIL-STD-202: 208 MIL-STD-750: 202 MIL-STD-883: 200 JIS C 7021: A-2